SN74BCT757 OCTAL BUFFER/DRIVER WITH OPEN-COLLECTOR OUTPUTS SCBS041D – NOVEMBER 1989 – REVISED NOVEMBER 1993

- BiCMOS Design Significantly Reduces I_{CCZ}
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Open-Collector Outputs Drive Bus Lines or Buffer Memory Address Registers
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic 300-mil DIPs (N)

description

This octal buffer and line driver is designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. This device provides complementary output-enable (OE and \overline{OE}) inputs and noninverting outputs.

The SN74BCT757 is characterized for operation from 0°C to 70°C.

FUNCTION TABLES

INPL	JTS	OUTPUT
10E	1A	1Y
Н	Х	Н
L	L	L
L	Н	Н

INPU	JTS	OUTPUT
20E	2A	2Y
L	Х	Н
н	L	L
Н	Н	Н

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

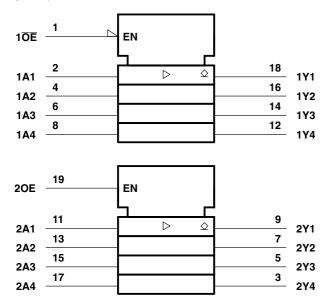


DW OR N PACKAGE (TOP VIEW)									
1 0E	Г₁	$ \overline{\mathbf{U}}_{20} $	Τ	V _{CC}					
1A1		19	ь.	20E					
2Y4	[] 3	18	b	1Y1					
1A2	4	17	þ	2A4					
2Y3	5	16	; []	1Y2					
1A3	6	15	; D	2A3					
2Y2	[7	14	Ъ	1Y3					
1A4	8]	13	β	2A2					
2Y1	9	12	2	1Y4					
GND	10) 11	þ	2A1					

SN74BCT757 OCTAL BUFFER/DRIVER WITH OPEN-COLLECTOR OUTPUTS

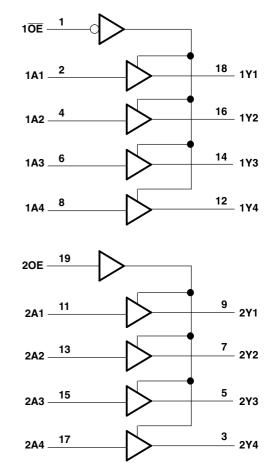
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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, V ₁	–0.5 V to 7 V
Input current range, I ₁	-30 mA to 5 mA
Voltage range applied to any output in the disabled or power-off state, Vo	-0.5 V to 5.5 V
Voltage range applied to any output in the high state, V _O	. –0.5 V to V _{CC}
Current into any output in the low state, I _O	128 mA
Operating free-air temperature range	0°C to 70°C
Storage temperature range	–65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



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recommended operating conditions (see Note 1)

		MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			V
V _{IL}	Low-level input voltage			0.8	V
V _{OH}	High-level output voltage			5.5	V
I _{IK}	Input clamp current			-18	mA
I _{OL}	Low-level output current			64	mA
T _A	Operating free-air temperature	0		70	°C

NOTE 1: Unused or floating inputs must be held high or low.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN TY	YP† N	MAX	UNIT	
V _{IK}	$V_{CC} = 4.5 V,$	l _l = –18 mA				-1.2	V
V _{OL}	$V_{CC} = 4.5 V,$	I _{OL} = 64 mA		0).42	0.55	V
I _I	$V_{CC} = 5.5 V,$	V _I = 7 V				0.1	mA
I _{IH}	$V_{CC} = 5.5 V,$	V _I = 2.7 V				20	μA
۱ _{IL}	$V_{CC} = 5.5 V,$	$V_{I} = 0.5 V$			-1	mA	
I _{OH}	$V_{CC} = 4.5 V,$	V _{OH} = 5.5 V				0.1	mA
			Outputs high			34	
I _{CC}	V _{CC} = 5.5 V,	Outputs open	Outputs low			77	mA
			OE and $\overline{\text{OE}}$ inactive			10	
Ci	V _{CC} = 5 V,	V _I = 2.5 V or 0.5 V			6		pF
Co	V _{CC} = 5 V,	V _O = 2.5 V or 0.5 V			4		pF

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Note 2)

PARAMETER	FROM	TO	V. T	_{CC} = 5 V _A = 25°C		MIN	МАХ	UNIT
	(INPUT)	(OUTPUT)	MIN	ТҮР	MAX			
t _{PLH}				8.3	9.6	6.6	10.1	
t _{PHL}	A	Ŷ	2.4	4.2	6	2	6.6 ^{ns}	ns
t _{PLH}	20E	V	11	14.8	17.9	10.8	19.7	
t _{PHL}	20E	Ŷ		4.6	6.2	2.6	6.9	ns
t _{PLH}	1 0E	V	11.4	13.9	16.1	10	18	2
t _{PHL}	IOE	T	4.4	6.1	7.8	4	8.5	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
SN74BCT757DW	ACTIVE	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	BCT757	Samples
SN74BCT757N	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74BCT757N	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

TEXAS INSTRUMENTS

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TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74BCT757DW	DW	SOIC	20	25	507	12.83	5080	6.6
SN74BCT757N	N	PDIP	20	20	506	13.97	11230	4.32

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW0020A



PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



DW0020A

EXAMPLE BOARD LAYOUT

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



DW0020A

EXAMPLE STENCIL DESIGN

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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